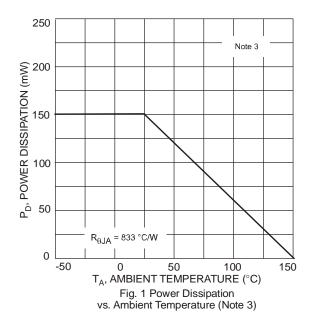
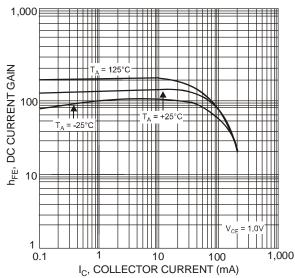


# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 6)								
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-40		V	$I_C = -10\mu A, I_E = 0$			
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-40		V	$I_C = -1.0 \text{mA}, I_B = 0$			
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5.0		V	$I_E = -10\mu A, I_C = 0$			
Collector Cutoff Current	I <sub>CEX</sub>		-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$			
Base Cutoff Current	I <sub>BL</sub>		-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$			
ON CHARACTERISTICS (Note 6)								
DC Current Gain	h <sub>FE</sub>	60 80 100 60 30	 300  		$I_{C} = -100\mu A, V_{CE} = -1.0V$ $I_{C} = -1.0mA, V_{CE} = -1.0V$ $I_{C} = -10mA, V_{CE} = -1.0V$ $I_{C} = -50mA, V_{CE} = -1.0V$ $I_{C} = -100mA, V_{CE} = -1.0V$			
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	_	-0.25 -0.40	V	$I_C = -10$ mA, $I_B = -1.0$ mA $I_C = -50$ mA, $I_B = -5.0$ mA			
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>	-0.65 —	-0.85 -0.95	V	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$			
SMALL SIGNAL CHARACTERISTICS								
Output Capacitance	C <sub>obo</sub>	—	4.5	pF	$V_{CB} = -5.0V$ , $f = 1.0MHz$ , $I_E = 0$			
Input Capacitance	C <sub>ibo</sub>	—	10	pF	$V_{EB} = -0.5V$ , $f = 1.0MHz$ , $I_{C} = 0$			
Input Impedance	h <sub>ie</sub>	2.0	12	kΩ	]			
Voltage Feedback Ratio	h <sub>re</sub>	0.1	10	x 10 <sup>-4</sup>	$V_{CE} = 10V, I_{C} = 1.0mA,$			
Small Signal Current Gain	h <sub>fe</sub>	100	400		f = 1.0kHz			
Output Admittance	h <sub>oe</sub>	3.0	60	μS				
Current Gain-Bandwidth Product	f <sub>T</sub>	250		MHz	$V_{CE} = -20V, I_{C} = -10mA,$ f = 100MHz			
Noise Figure	NF	_	4.0	dB	$V_{CE}$ = -5.0V, $I_{C}$ = -100 $\mu$ A, $R_{S}$ = 1.0k $\Omega$ , $f$ = 1.0kHz			
SWITCHING CHARACTERISTICS								
Delay Time	t <sub>d</sub>	_	35	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$			
Rise Time	t <sub>r</sub>	_	35	ns	$V_{BE(off)} = 0.5V, I_{B1} = -1.0mA$			
Storage Time	ts	_	225	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$			
Fall Time	t <sub>f</sub>		75	ns	$I_{B1} = I_{B2} = -1.0 \text{mA}$			

Notes: 6. Short duration pulse test used to minimize self-heating effect.

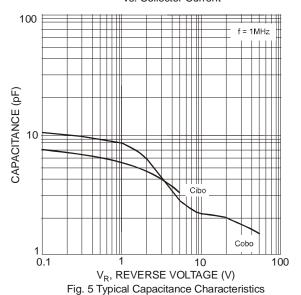






# COLLECTOR-EMITTER (3) VCE(SAT), COLLECTOR-EMITTER (3) OUT 1 10 10 10 1,000 1,000 1,000

Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current



### NOT RECOMMENDED FOR NEW DESIGNS USE MMDT3906VC

### **MMDT3906V**

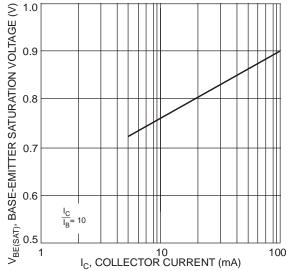


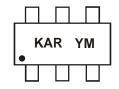
Fig. 4 Typical Base-Emitter Saturation Voltage vs. Collector Current

# Ordering Information (Note 7)

Part Number	Case	Packaging		
MMDT3906V-7	SOT-563	3000/Tape & Reel		

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

### **Marking Information**



KAR = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

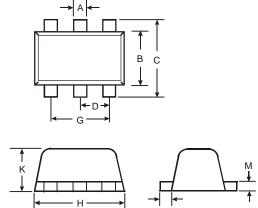
Date Code Key

Year	2005	2006	2007	2008	200	9 2	010	20	011	2012	2013	2014	2015
Code	S	T	U	V	W		Χ		Υ	Z	Α	В	С
Month	Jan	Feb	Mar	Apr	May	Jun	J	ul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	-	7	8	9	0	N	D



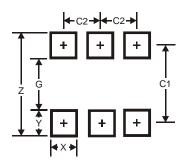


# **Package Outline Dimensions**



SOT-563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	D -		0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
K	0.55	0.60	0.60				
L	0.10	0.30	0.20				
M	0.10	0.18	0.11				
All	All Dimensions in mm						

# Suggested Pad Layout



Dimensions	Value (in mm)		
Z	2.2		
G	1.2		
Х	0.375		
Y	0.5		
C1	1.7		
C2	0.5		



### NOT RECOMMENDED FOR NEW DESIGNS USE MMDT3906VC

**MMDT3906V** 

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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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